HSMY-C240

Mono Color Side View ChipLED

Data Sheet

Features

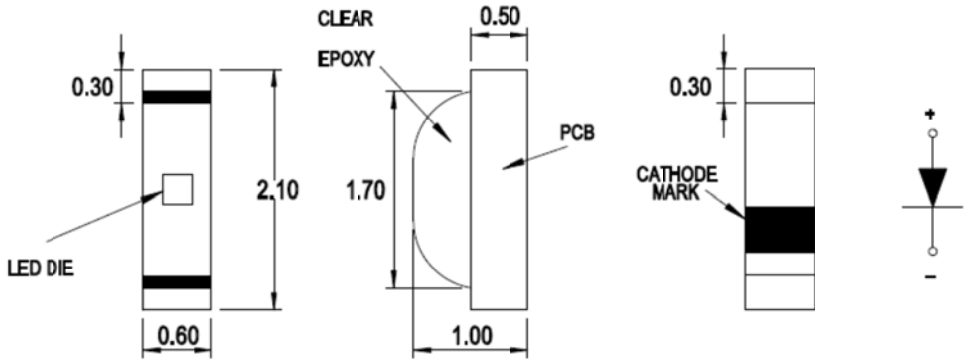
- LED with GaP Yellow
- Compatible with reflow soldering
- Available in 8mm tape and 7" diameter reel

Applications

- Indicator
- Backlighting

CAUTION: This LED is Class 1A ESD sensitive per ANSI/ESDA/JEDEC JS-001. Please observe appropriate precautions during handling and processing. Refer to application note AN-1142 for additional details.

Figure 1 Package Dimensions



NOTE

1. All dimensions in millimeters.
2. Tolerance is ±0.10mm unless otherwise specified.

Absolute Maximum Ratings

Parameters	Value	Unit
DC Forward Current [a]	20	mA
Power Dissipation	52	mW
LED Junction Temperature	95	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +85	°C

a. Derate linearly as shown in Figure 6.

Optical Characteristics (T_J = 25°C, I_F = 20mA)

Color	Luminous Intensity, I_V (mcd) [a]	Dominant Wavelength, λ_d (nm) [b]	Peak Wavelength, λ_p (nm)	Viewing Angle $2\theta_{1/2}$ (Degrees) [c]
	Min.	Typ.	Typ.	Typ.
Yellow	2.8	586	589	170

a. The luminous intensity, I_V is measured at the mechanical axis of the LED package. The actual peak of the spatial radiation pattern may not be aligned with the axis.
b. The dominant wavelength is derived from the CIE Chromaticity diagram and represents the perceived color of the device.
c. $\Theta_{1/2}$ is the off axis angle where the luminous intensity is ½ the peak intensity.

Electrical Characteristics (T_J = 25°C, I_F = 20mA)

Color	Forward Voltage, V_F (V) [a]		Reverse Current, I_R (µA) at V_R = 5V [b]	Thermal Resistance, $R_{\theta J\text{-}S}$ (°C/W) [c]
	Min.	Max.	Max.	Typ.
Yellow	1.6	2.6	100	600

a. Forward voltage tolerance = ±0.1V.
b. Indicates product final test condition only. Long term reverse bias is not recommended.
c. Thermal resistance from LED junction to solder point.

Bin Information

Intensity Bin Limits (CAT)

Bin ID	Luminous Intensity, I_V (mcd)	
	Min.	Max.
H	2.8	4.5
J	4.5	7.2
K	7.2	11.2
L	11.2	18.0
M	18.0	28.5
N	28.5	45.0

Tolerance = ±15%

Color Bin Limits (BIN)

Bin ID	Dominant Wavelength, λ_d (nm)	
	Min.	Max.
A	582.0	584.5
B	584.5	587.0
C	587.0	589.5
D	589.5	592.0
E	592.0	594.5
F	594.5	597.0

Tolerance = ±1.0nm

Indication of bin information on reel and packaging label:

CAT : x – Intensity bin
BIN : x – Color bin

Figure 2 Spectral Power Distribution

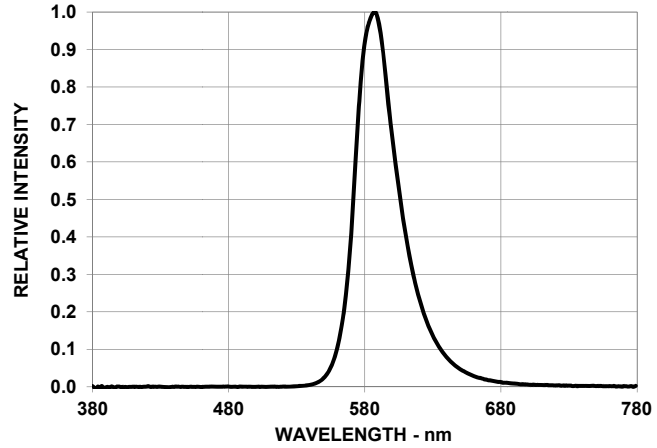


Figure 3 Relative Luminous Intensity

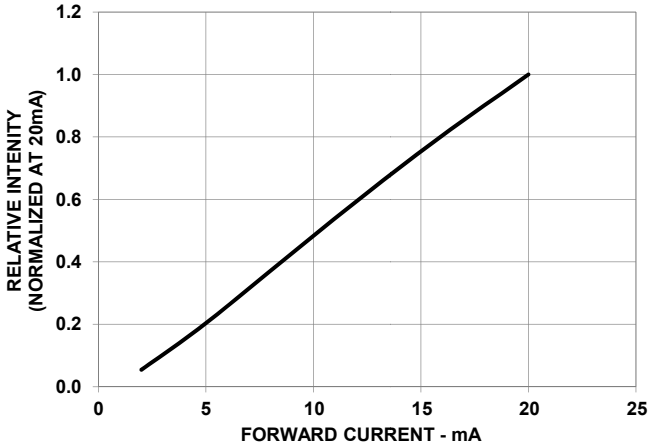


Figure 4 Forward Current vs. Forward Voltage

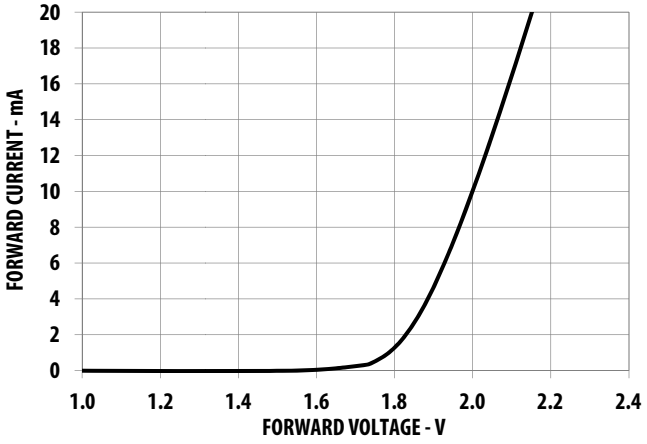


Figure 5 Radiation Pattern

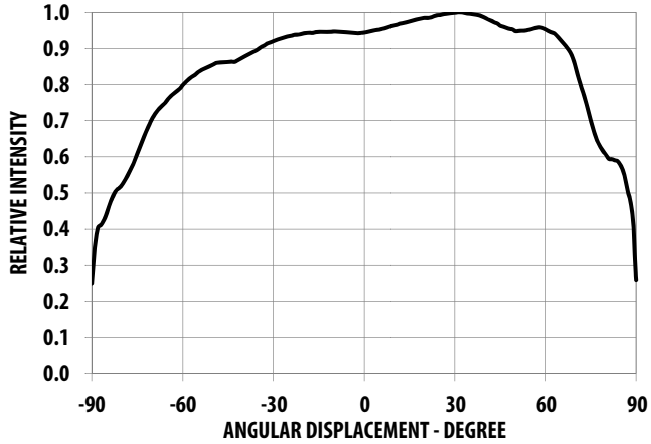


Figure 6 Derating Curve

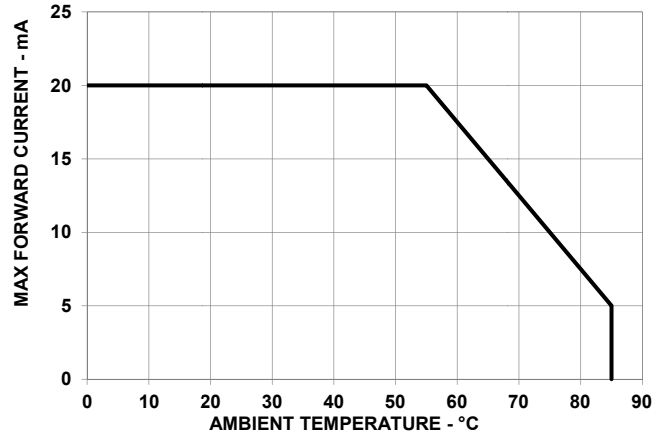
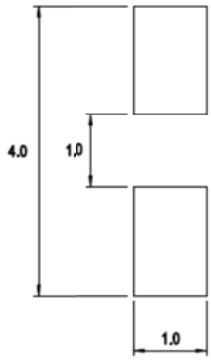


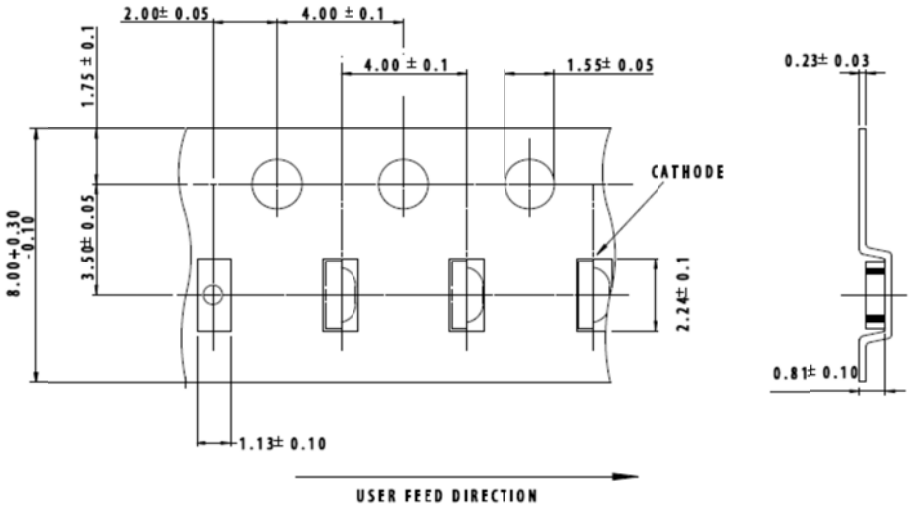
Figure 7 Recommended Soldering Land Pattern



NOTE

1. All dimensions in millimeters.
2. Tolerance is ±0.10mm unless otherwise specified.

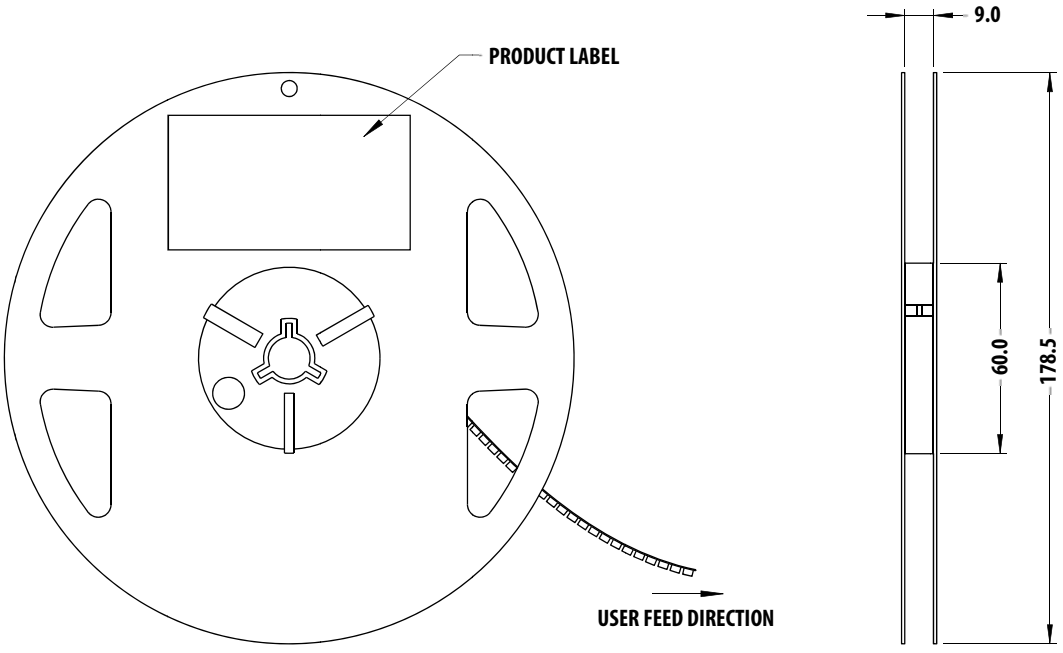
Figure 8 Carrier Tape Dimensions



NOTE

1. All dimensions in millimeters.
2. Tolerance is ±0.10mm unless otherwise specified.

Figure 9 Reel Dimensions



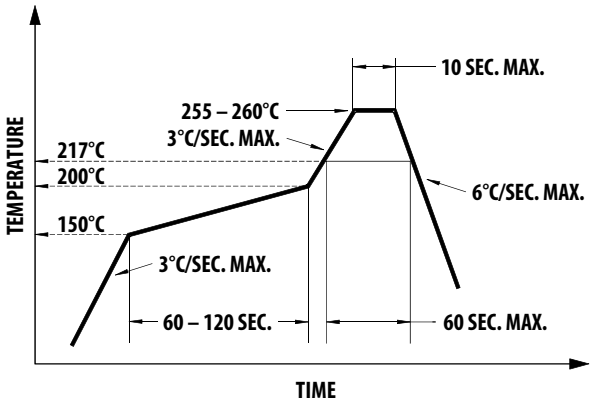
NOTE All dimensions are in millimeters (mm).

Precautionary Notes

Soldering

- Do not perform reflow soldering more than twice. Observe necessary precautions of handling moisture-sensitive device as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- Use reflow soldering to solder the LED. Use hand soldering only for rework if unavoidable, but it must be strictly controlled to following conditions:
  - Soldering iron tip temperature = 310°C max.
  - Soldering duration = 2sec max.
  - Number of cycles = 1 only
  - Power of soldering iron = 50W max.
- Do not touch the LED package body with the soldering iron except for the soldering terminals, as it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED is affected by soldering with hand soldering.

Figure 10 Recommended Lead-Free Reflow Soldering Profile



Handling of Moisture-Sensitive Devices

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices* for additional details and a review of proper handling procedures.

- Before use:
  - An unopened moisture barrier bag (MBB) can be stored at <40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the Humidity Indicator Card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
  - Do not open the MBB prior to assembly (for example, for IQC). If unavoidable, MBB must be properly resealed with fresh desiccant and HIC. The exposed duration must be taken in as floor life.
- Control after opening the MBB:
  - Read the HIC immediately upon opening of MBB.
  - Keep the LEDs at <30°/60%RH at all times, and complete all high temperature-related processes, including soldering, curing or rework within 672 hours.
- Control for unfinished reel:

  Store unused LEDs in a sealed MBB with desiccant or a desiccator at <5%RH.
- Control of assembled boards:

  If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or desiccator at <5% RH to ensure that all LEDs have not exceeded their floor life of 672 hours.
- Baking is required if:
  - The HIC indicator indicates a change in color for 10% and 5%, as stated on the HIC.
  - The LEDs are exposed to conditions of >30°C/60% RH at any time.
  - The LED's floor life exceeded 672 hours.

  The recommended baking condition is: 60 ±5°C for 20 hours.

  Baking can only be done once.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the Data Sheet. Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of forward voltage (V_F) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (meaning: intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- If the LED is intended to be used along with LED of other color to achieve color mixing, Broadcom does not guarantee the consistency of the resultant color. Do

contact Broadcom Sale Representative for such application.

- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Avoid rapid change in ambient temperature, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in harsh or outdoor environment, protect the LED against damages caused by rain water, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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